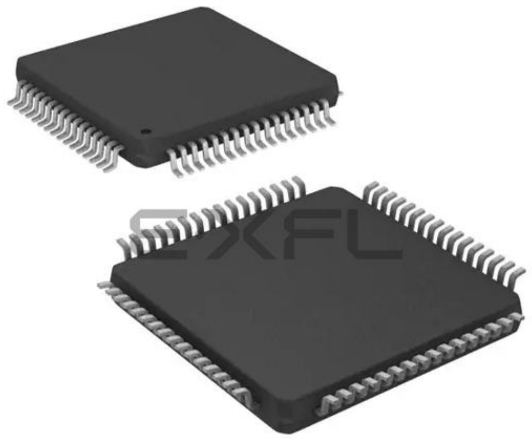

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	33MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	50
Program Memory Size	32KB (16K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	902 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c756at-33-pt

TABLE 5-4: INITIALIZATION CONDITIONS FOR SPECIAL FUNCTION REGISTERS

Register	Address	Power-on Reset Brown-out Reset	$\overline{\text{MCLR}}$ Reset WDT Reset	Wake-up from SLEEP through Interrupt
Unbanked				
INDF0	00h	N/A	N/A	N/A
FSR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h	0000h	0000h	PC + 1(2)
PCLATH	03h	0000 0000	uuuu uuuu	uuuu uuuu
ALUSTA	04h	1111 xxxx	1111 uuuu	1111 uuuu
T0STA	05h	0000 000-	0000 000-	0000 000-
CPUSTA(3)	06h	--11 11qq	--11 qquu	--uu qquu
INTSTA	07h	0000 0000	0000 0000	uuuu uuuu(1)
INDF1	08h	N/A	N/A	N/A
FSR1	09h	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	0Ah	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0L	0Bh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0H	0Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRL	0Dh	0000 0000	0000 0000	uuuu uuuu
TBLPTRH	0Eh	0000 0000	0000 0000	uuuu uuuu
BSR	0Fh	0000 0000	0000 0000	uuuu uuuu
Bank 0				
PORTA(4,6)	10h	0-xx 11xx	0-uu 11uu	u-uu uuuu
DDRB	11h	1111 1111	1111 1111	uuuu uuuu
PORTB(4)	12h	xxxx xxxx	uuuu uuuu	uuuu uuuu
RCSTA1	13h	0000 -00x	0000 -00u	uuuu -uuu
RCREG1	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA1	15h	0000 --1x	0000 --1u	uuuu --uu
TXREG1	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SPBRG1	17h	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented, read as '0', q = value depends on condition

Note 1: One or more bits in INTSTA, PIR1, PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GLINTD bit is cleared, the PC is loaded with the interrupt vector.

3: See Table 5-3 for RESET value of specific condition.

4: This is the value that will be in the port output latch.

5: When the device is configured for Microprocessor or Extended Microcontroller mode, the operation of this port does not rely on these registers.

6: On any device RESET, these pins are configured as inputs.

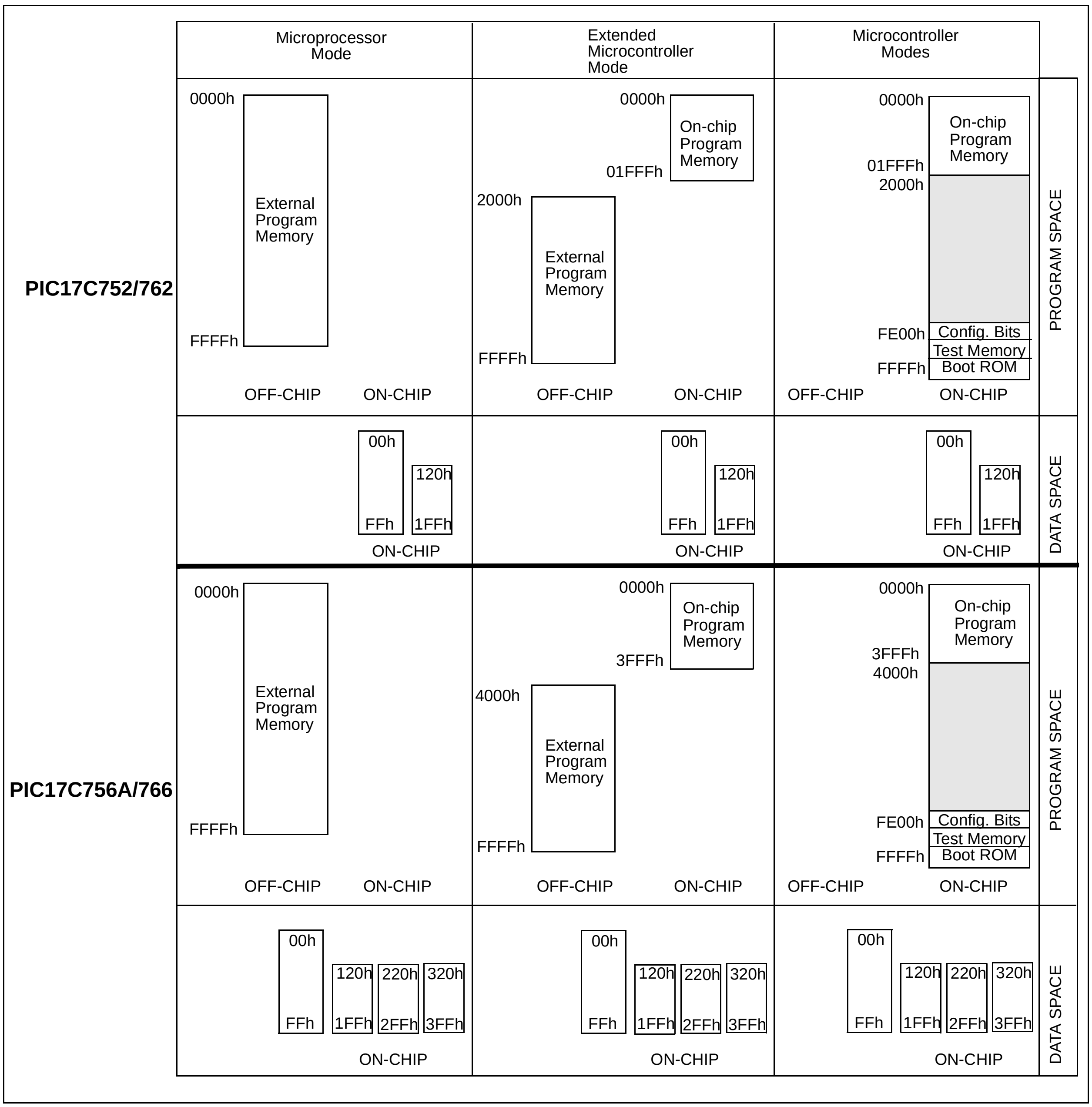
TABLE 7-1: MODE MEMORY ACCESS

Operating Mode	Internal Program Memory	Configuration Bits, Test Memory, Boot ROM
Microprocessor	No Access	No Access
Microcontroller	Access	Access
Extended Microcontroller	Access	No Access
Protected Microcontroller	Access	Access

The PIC17C7XX can operate in modes where the program memory is off-chip. They are the Microprocessor and Extended Microcontroller modes. The Microprocessor mode is the default for an unprogrammed device.

Regardless of the processor mode, data memory is always on-chip.

FIGURE 7-2: MEMORY MAP IN DIFFERENT MODES



10.0 I/O PORTS

PIC17C75X devices have seven I/O ports, PORTA through PORTG. PIC17C76X devices have nine I/O ports, PORTA through PORTJ. PORTB through PORTJ have a corresponding Data Direction Register (DDR), which is used to configure the port pins as inputs or outputs. Some of these ports pins are multiplexed with alternate functions.

PORTC, PORTD, and PORTE are multiplexed with the system bus. These pins are configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, these pins are general purpose I/O.

PORTA, PORTB, PORTE<3>, PORTF, PORTG and the upper four bits of PORTH are multiplexed with the peripheral features of the device. These peripheral features are:

- Timer Modules
- Capture Modules
- PWM Modules
- USART/SCI Modules
- SSP Module
- A/D Module
- External Interrupt pin

When some of these peripheral modules are turned on, the port pin will automatically configure to the alternate function. The modules that do this are:

- PWM Module
- SSP Module
- USART/SCI Module

When a pin is automatically configured as an output by a peripheral module, the pins data direction (DDR) bit is unknown. After disabling the peripheral module, the user should re-initialize the DDR bit to the desired configuration.

The other peripheral modules (which require an input) must have their data direction bits configured appropriately.

Note:	A pin that is a peripheral input, can be configured as an output (DDRx<y> is cleared). The peripheral events will be determined by the action output on the port pin.

When the device enters the "RESET state", the Data Direction registers (DDR) are forced set, which will make the I/O hi-impedance inputs. The RESET state of some peripheral modules may force the I/O to other operations, such as analog inputs or the system bus.

13.1.3.3 External Clock Source

The PWMs will operate, regardless of the clock source of the timer. The use of an external clock has ramifications that must be understood. Because the external TCLK12 input is synchronized internally (sampled once per instruction cycle), the time TCLK12 changes to the time the timer increments, will vary by as much as 1TCY (one instruction cycle). This will cause jitter in the duty cycle as well as the period of the PWM output.

This jitter will be ±1TCY, unless the external clock is synchronized with the processor clock. Use of one of the PWM outputs as the clock source to the TCLK12 input, will supply a synchronized clock.

In general, when using an external clock source for PWM, its frequency should be much less than the device frequency (FOSC).

13.1.3.4 Maximum Resolution/Frequency for External Clock Input

The use of an external clock for the PWM time base (Timer1 or Timer2) limits the PWM output to a maximum resolution of 8-bits. The PWxDCL<7:6> bits must be kept cleared. Use of any other value will distort the PWM output. All resolutions are supported when internal clock mode is selected. The maximum attainable frequency is also lower. This is a result of the timing requirements of an external clock input for a timer (see the Electrical Specification section). The maximum PWM frequency, when the timers clock source is the RB4/TCLK12 pin, is shown in Table 13-4 (Standard Resolution mode).

TABLE 13-5: REGISTERS/BITS ASSOCIATED WITH PWM

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	$\overline{\text{MCLR}}$, WDT
16h, Bank 3	TCON1	CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS	0000 0000	0000 0000
17h, Bank 3	TCON2	CA2OVF	CA1OVF	PWM2ON	PWM1ON	CA1/$\overline{\text{PR3}}$	TMR3ON	TMR2ON	TMR1ON	0000 0000	0000 0000
16h, Bank 7	TCON3	—	CA4OVF	CA3OVF	CA4ED1	CA4ED0	CA3ED1	CA3ED0	PWM3ON	-000 0000	-000 0000
10h, Bank 2	TMR1	Timer1's Register								xxxx xxxx	uuuu uuuu
11h, Bank 2	TMR2	Timer2's Register								xxxx xxxx	uuuu uuuu
16h, Bank 1	PIR1	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TX1IF	RC1IF	x000 0010	u000 0010
17h, Bank 1	PIE1	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TX1IE	RC1IE	0000 0000	0000 0000
07h, Unbanked	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
06h, Unbanked	CPUSTA	—	—	STKAV	GLINTD	$\overline{\text{TO}}$	$\overline{\text{PD}}$	POR	BOR	--11 11qq	--11 qquu
14h, Bank 2	PR1	Timer1 Period Register								xxxx xxxx	uuuu uuuu
15h, Bank 2	PR2	Timer2 Period Register								xxxx xxxx	uuuu uuuu
10h, Bank 3	PW1DCL	DC1	DC0	—	—	—	—	—	—	xx-- ----	uu-- ----
11h, Bank 3	PW2DCL	DC1	DC0	TM2PW2	—	—	—	—	—	xx0- ----	uu0- ----
10h, Bank 7	PW3DCL	DC1	DC0	TM2PW3	—	—	—	—	—	xx0- ----	uu0- ----
12h, Bank 3	PW1DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
13h, Bank 3	PW2DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
11h, Bank 7	PW3DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', q = value depends on conditions.
Shaded cells are not used by PWM Module.

13.2.4 EXTERNAL CLOCK INPUT FOR TIMER3

When TMR3CS is set, the 16-bit TMR3 increments on the falling edge of clock input TCLK3. The input on the RB5/TCLK3 pin is sampled and synchronized by the internal phase clocks, twice every instruction cycle. This causes a delay from the time a falling edge appears on TCLK3 to the time TMR3 is actually incremented. For the external clock input timing requirements, see the Electrical Specification section. Figure 13-7 shows the timing diagram when operating from an external clock.

13.2.5 READING/WRITING TIMER3

Since Timer3 is a 16-bit timer and only 8-bits at a time can be read or written, care should be taken when reading or writing while the timer is running. The best method is to stop the timer, perform any read or write operation and then restart Timer3 (using the TMR3ON bit). However, if it is necessary to keep Timer3 free-running, care must be taken. For writing to the 16-bit TMR3, Example 13-2 may be used. For reading the 16-bit TMR3, Example 13-3 may be used. Interrupts must be disabled during this routine.

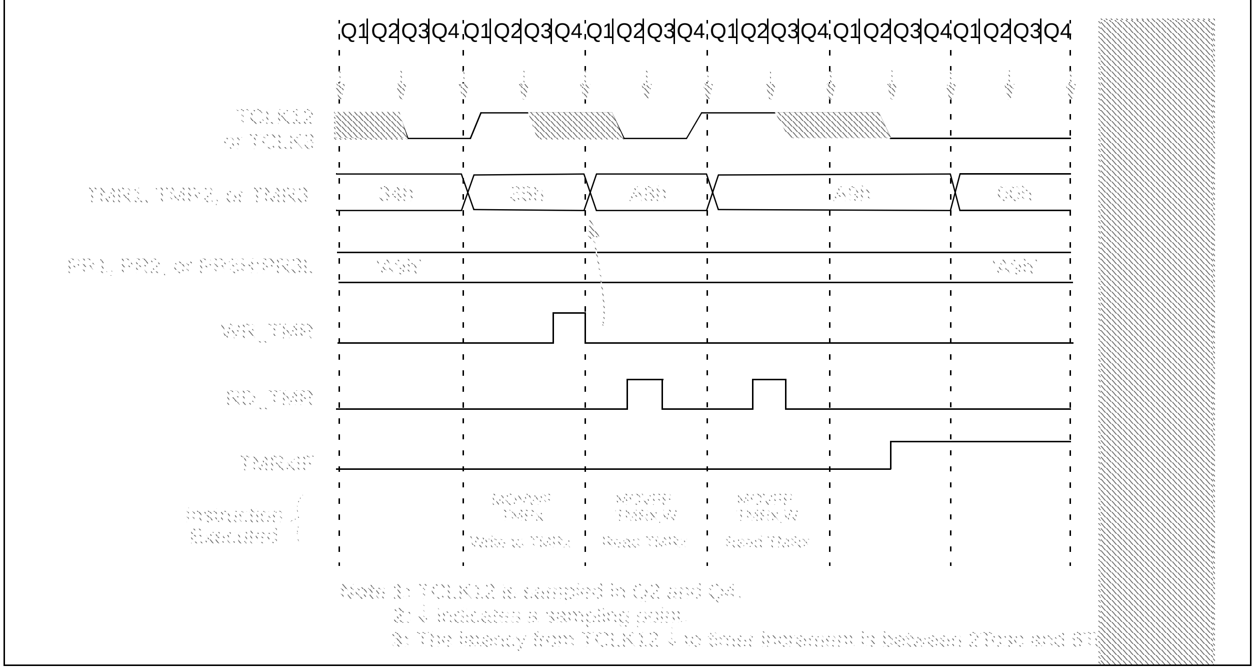
EXAMPLE 13-2: WRITING TO TMR3

```
BSF     CPUSTA, GLINTD     ; Disable interrupts
MOVFP   RAM_L,  TMR3L      ;
MOVFP   RAM_H,  TMR3H      ;
BCF     CPUSTA, GLINTD     ; Done, enable interrupts
```

EXAMPLE 13-3: READING FROM TMR3

```
MOVPF   TMR3L, TMPLO      ; read low TMR3
MOVPF   TMR3H, TMPHI      ; read high TMR3
MOVFP   TMPLO, WREG       ; tmplo -> wreg
CPFSLT  TMR3L             ; TMR3L < wreg?
RETURN                    ; no then return
MOVPF   TMR3L, TMPLO      ; read low TMR3
MOVPF   TMR3H, TMPHI      ; read high TMR3
RETURN                    ; return
```

FIGURE 13-7: TIMER1, TIMER2 AND TIMER3 OPERATION (IN COUNTER MODE)



The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc. The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous - Master (half duplex)
- Synchronous - Slave (half duplex)

The SPEN (RCSTA<7>) bit has to be set in order to configure the I/O pins as the Serial Communication Interface (USART).

The USART module will control the direction of the RX/DT and TX/CK pins, depending on the states of the USART configuration bits in the RCSTA and TXSTA registers. The bits that control I/O direction are:

- SPEN
- TXEN
- SREN
- CREN
- CSRC

REGISTER 14-2: RCSTA1 REGISTER (ADDRESS: 13h, BANK 0)
RCSTA2 REGISTER (ADDRESS: 13h, BANK 4)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D
bit 7							bit 0

bit 7 **SPEN**: Serial Port Enable bit
1 = Configures TX/CK and RX/DT pins as serial port pins
0 = Serial port disabled

bit 6 **RX9**: 9-bit Receive Select bit
1 = Selects 9-bit reception
0 = Selects 8-bit reception

bit 5 **SREN**: Single Receive Enable bit
This bit enables the reception of a single byte. After receiving the byte, this bit is automatically cleared.

Synchronous mode:
1 = Enable reception
0 = Disable reception

Note: This bit is ignored in synchronous slave reception.

Asynchronous mode:
Don't care

bit 4 **CREN**: Continuous Receive Enable bit
This bit enables the continuous reception of serial data.

Asynchronous mode:
1 = Enable continuous reception
0 = Disables continuous reception

Synchronous mode:
1 = Enables continuous reception until CREN is cleared (CREN overrides SREN)
0 = Disables continuous reception

bit 3 **Unimplemented**: Read as '0'

bit 2 **FERR**: Framing Error bit
1 = Framing error (updated by reading RCREG)
0 = No framing error

bit 1 bit **OERR**: Overrun Error bit
1 = Overrun (cleared by clearing CREN)
0 = No overrun error

bit 0 **RX9D**: 9th bit of Receive Data (can be the software calculated parity bit)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR Reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

14.3.2 USART SYNCHRONOUS MASTER RECEPTION

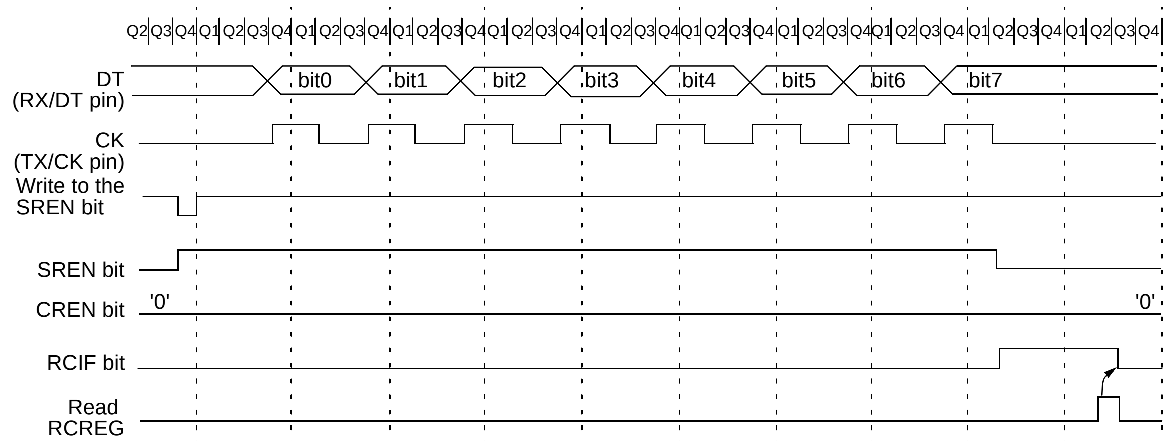
Once Synchronous mode is selected, reception is enabled by setting either the SREN (RCSTA<5>) bit or the CREN (RCSTA<4>) bit. Data is sampled on the RX/DT pin on the falling edge of the clock. If SREN is set, then only a single word is received. If CREN is set, the reception is continuous until CREN is reset. If both bits are set, then CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to RCREG (if it is empty). If the transfer is complete, the interrupt bit RCIF is set. The actual interrupt can be enabled/disabled by setting/clearing the RCIE bit. RCIF is a read only bit which is reset by the hardware. In this case, it is reset when RCREG has been read and is empty. RCREG is a double buffered register; i.e., it is a two deep FIFO. It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR. On the clocking of the last bit of the third byte, if RCREG is still full, then the overrun error bit OERR (RCSTA<1>) is set. The word in the RSR will be lost. RCREG can be read twice to retrieve the two bytes in the FIFO. The OERR bit has to be cleared in software. This is done by clearing the CREN bit. If OERR is set, transfers from RSR to RCREG are inhibited, so it is essential to clear the OERR bit if it is set. The 9th receive bit is buffered the same way as the receive data. Reading the RCREG register will allow the RX9D and FERR bits to be loaded with values for the next received data; therefore, it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

Steps to follow when setting up a Synchronous Master Reception:

1. Initialize the SPBRG register for the appropriate baud rate. See Section 14.1 for details.
2. Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
3. If interrupts are desired, then set the RCIE bit.
4. If 9-bit reception is desired, then set the RX9 bit.
5. If a single reception is required, set bit SREN. For continuous reception set bit CREN.
6. The RCIF bit will be set when reception is complete and an interrupt will be generated if the RCIE bit was set.
7. Read RCSTA to get the ninth bit (if enabled) and determine if any error occurred during reception.
8. Read the 8-bit received data by reading RCREG.
9. If any error occurred, clear the error by clearing CREN.

Note:	To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic so that it will be in the proper state when receive is re-enabled.

FIGURE 14-10: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



Note: Timing diagram demonstrates SYNC Master mode with SREN = 1.

16.4.1 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is the location where the 10-bit A/D result is loaded at the completion of the A/D conversion. This register pair is 16-bits wide. The A/D module gives the flexibility to left or right justify the 10-bit result in the 16-bit result register. The A/D Format Select bit (ADFM) controls this justification. Figure 16-6 shows the operation of the A/D result justification. The extra bits are loaded with '0's'. When an A/D result will not overwrite these locations (A/D disable), these registers may be used as two general purpose 8-bit registers.

16.5 A/D Operation During SLEEP

The A/D module can operate during SLEEP mode. This requires that the A/D clock source be set to RC (ADCS1:ADCS0 = `11`). When the RC clock source is selected, the A/D module waits one instruction cycle before starting the conversion. This allows the `SLEEP` instruction to be executed, which eliminates all digital switching noise from the conversion. When the conversion is completed, the GO/$\overline{\text{DONE}}$ bit will be cleared, and the result loaded into the ADRES register. If the A/D interrupt is enabled, the device will wake-up from SLEEP. If the A/D interrupt is not enabled, the A/D module will then be turned off, although the ADON bit will remain set.

When the A/D clock source is another clock option (not RC), a `SLEEP` instruction will cause the present conversion to be aborted and the A/D module to be turned off, though the ADON bit will remain set.

Turning off the A/D places the A/D module in its lowest current consumption state.

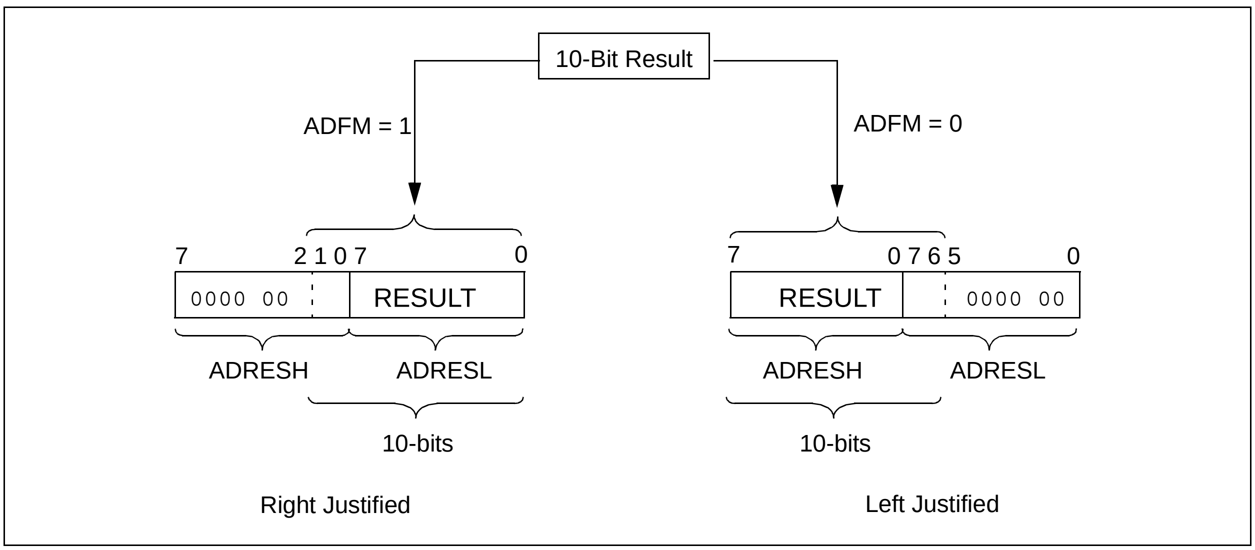
Note:	For the A/D module to operate in SLEEP, the A/D clock source must be set to RC (ADCS1:ADCS0 = `11`). To allow the conversion to occur during SLEEP, ensure the `SLEEP` instruction immediately follows the instruction that sets the GO/$\overline{\text{DONE}}$ bit.

16.6 Effects of a RESET

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off, and any conversion is aborted.

The value that is in the ADRESH:ADRESL registers is not modified for a Power-on Reset. The ADRESH:ADRESL registers will contain unknown data after a Power-on Reset.

FIGURE 16-6: A/D RESULT JUSTIFICATION



ADDWFC — ADD WREG and Carry bit to f

Syntax:	[*label*] ADDWFC f,d
Operands:	0 ≤ f ≤ 255 d ∈ [0,1]
Operation:	(WREG) + (f) + C → (dest)
Status Affected:	OV, C, DC, Z
Encoding:	`0001` `000d` `ffff` `ffff`
Description:	Add WREG, the Carry Flag and data memory location 'f'. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed in data memory location 'f'.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `ADDWFC REG 0`

Before Instruction
- Carry bit = 1
- REG = 0x02
- WREG = 0x4D

After Instruction
- Carry bit = 0
- REG = 0x02
- WREG = 0x50

ANDLW — And Literal with WREG

Syntax:	[*label*] ANDLW k
Operands:	0 ≤ k ≤ 255
Operation:	(WREG) .AND. (k) → (WREG)
Status Affected:	Z
Encoding:	`1011` `0101` `kkkk` `kkkk`
Description:	The contents of WREG are AND'ed with the 8-bit literal 'k'. The result is placed in WREG.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to WREG

Example: `ANDLW 0x5F`

Before Instruction
- WREG = 0xA3

After Instruction
- WREG = 0x03

CPFSEQ — Compare f with WREG, skip if f = WREG

Syntax:	[*label*] CPFSEQ f
Operands:	$0 \le f \le 255$
Operation:	(f) – (WREG), skip if (f) = (WREG) (unsigned comparison)
Status Affected:	None
Encoding:	`0011` `0001` `ffff` `ffff`
Description:	Compares the contents of data memory location 'f' to the contents of WREG by performing an unsigned subtraction. If 'f' = WREG, then the fetched instruction is discarded and a `NOP` is executed instead, making this a two-cycle instruction.
Words:	1
Cycles:	1 (2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

<u>Example</u>:

```
HERE     CPFSEQ REG
NEQUAL   :
EQUAL    :
```

Before Instruction

PC Address	=	`HERE`
WREG	=	?
REG	=	?

After Instruction

If REG	=	WREG;
PC	=	Address `(EQUAL)`
If REG	≠	WREG;
PC	=	Address `(NEQUAL)`

CPFSGT — Compare f with WREG, skip if f > WREG

Syntax:	[*label*] CPFSGT f
Operands:	$0 \le f \le 255$
Operation:	(f) – (WREG), skip if (f) > (WREG) (unsigned comparison)
Status Affected:	None
Encoding:	`0011` `0010` `ffff` `ffff`
Description:	Compares the contents of data memory location 'f' to the contents of the WREG by performing an unsigned subtraction. If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a `NOP` is executed instead, making this a two-cycle instruction.
Words:	1
Cycles:	1 (2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

<u>Example</u>:

```
HERE       CPFSGT REG
NGREATER   :
GREATER    :
```

Before Instruction

PC	=	Address `(HERE)`
WREG	=	?

After Instruction

If REG	>	WREG;
PC	=	Address `(GREATER)`
If REG	£	WREG;
PC	=	Address `(NGREATER)`

RETURN — Return from Subroutine

Syntax: [*label*] RETURN

Operands: None

Operation: TOS → PC;

Status Affected: None

Encoding:

0000	0000	0000	0010

Description: Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No operation	Process Data	POP PC from stack
No operation	No operation	No operation	No operation

Example: `RETURN`

After Interrupt
PC = TOS

RLCF — Rotate Left f through Carry

Syntax: [*label*] RLCF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

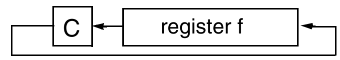
Operation: f<n> → d<n+1>;
f<7> → C;
C → d<0>

Status Affected: C

Encoding:

0001	101d	ffff	ffff

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is stored back in register 'f'.



Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `RLCF REG,0`

Before Instruction
REG = 1110 0110
C = 0

After Instruction
REG = 1110 0110
WREG = 1100 1100
C = 1

Param No.	Sym	Characteristic		Min	Max	Units	Conditions
110	Tbuf	Bus free time	100 kHz mode	4.7	—	ms	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	ms	
			1 MHz mode(1)	0.5	—	ms	
D102	Cb	Bus capacitive loading		—	400	pF	

Note 1: Maximum pin capacitance = 10 pF for all I^2C pins.

2: A fast mode (400 KHz) I^2C bus device can be used in a standard mode I^2C bus system, but the parameter # 107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line. Parameter #102 + #107 = 1000 + 250 = 1250 ns (for 100 kHz mode) before the SCL line is released.

3: C_b is specified to be from 10-400pF. The minimum specifications are characterized with C_b=10pF. The rise time spec (t_r) is characterized with R_p=R_p min. The minimum fall time specification (t_f) is characterized with C_b=10pF,and R_p=R_p max. These are only valid for fast mode operation (VDD=4.5-5.5V) and where the SPM bit (SSPSTAT<7>) =1.)

4: Max specifications for these parameters are valid for falling edge only. Specs are characterized with R_p=R_p min and C_b=400pF for standard mode, 200pF for fast mode, and 10pF for 1MHz mode.

FIGURE 20-19: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

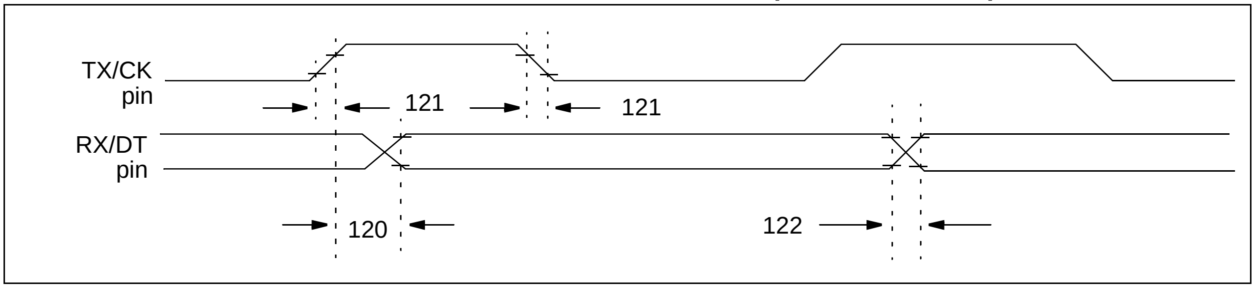


TABLE 20-14: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
120	TckH2dtV	SYNC XMIT (MASTER & SLAVE) Clock high to data out valid	PIC17**C**XXX	—	—	50	ns	
			PIC17**LC**XXX	—	—	75	ns	
121	TckRF	Clock out rise time and fall time (Master mode)	PIC17**C**XXX	—	—	25	ns	
			PIC17**LC**XXX	—	—	40	ns	
122	TdtRF	Data out rise time and fall time	PIC17**C**XXX	—	—	25	ns	
			PIC17**LC**XXX	—	—	40	ns	

† Data in “Typ” column is at 5V, 25°C unless otherwise stated.

FIGURE 20-20: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

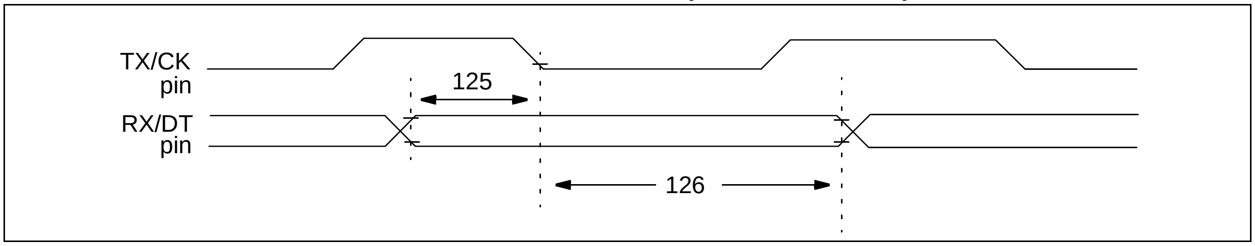


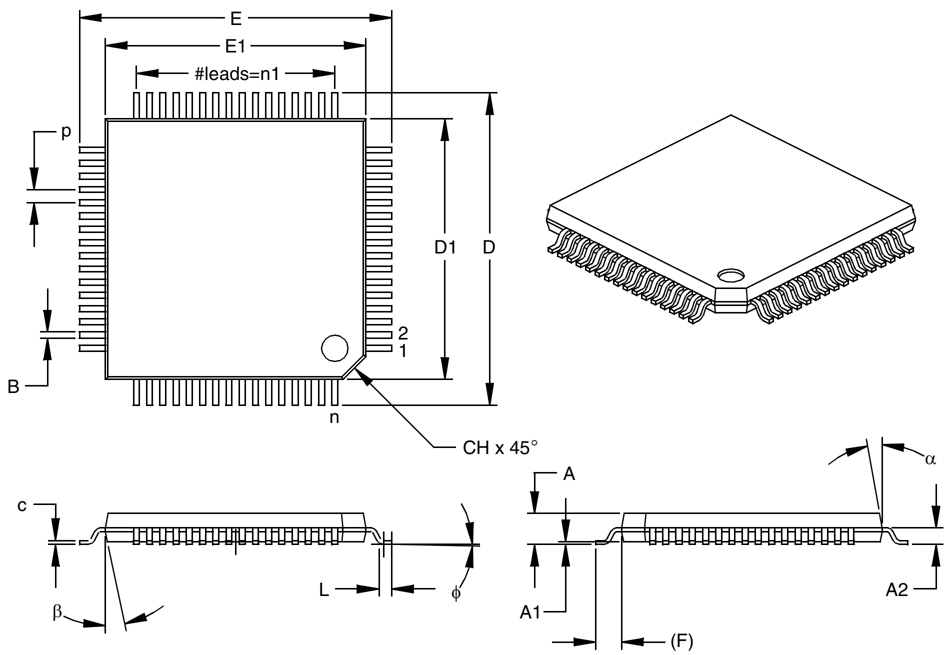
TABLE 20-15: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK↓ (DT setup time)	15	—	—	ns	
126	TckL2dtl	Data hold after CK↓ (DT hold time)	15	—	—	ns	

† Data in “Typ” column is at 5V, 25°C unless otherwise stated.

64-Lead Plastic Thin Quad Flatpack (PT) 10x10x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		64			64	
Pitch	p		.020			0.50	
Pins per Side	n1		16			16	
Overall Height	A	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	φ	0	3.5	7	0	3.5	7
Overall Width	E	.463	.472	.482	11.75	12.00	12.25
Overall Length	D	.463	.472	.482	11.75	12.00	12.25
Molded Package Width	E1	.390	.394	.398	9.90	10.00	10.10
Molded Package Length	D1	.390	.394	.398	9.90	10.00	10.10
Lead Thickness	c	.005	.007	.009	0.13	0.18	0.23
Lead Width	B	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-026
Drawing No. C04-085

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